

## Epiform® FOR ELECTRONIC COMPONENTS – POWDER RESIN

Electronic Component Epiform® is a resin used for various types of electronic components. Many grades are available, suitable for various applications in ceramic capacitors, varistors, thermistors and other small electronic components.

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### Powder Resins

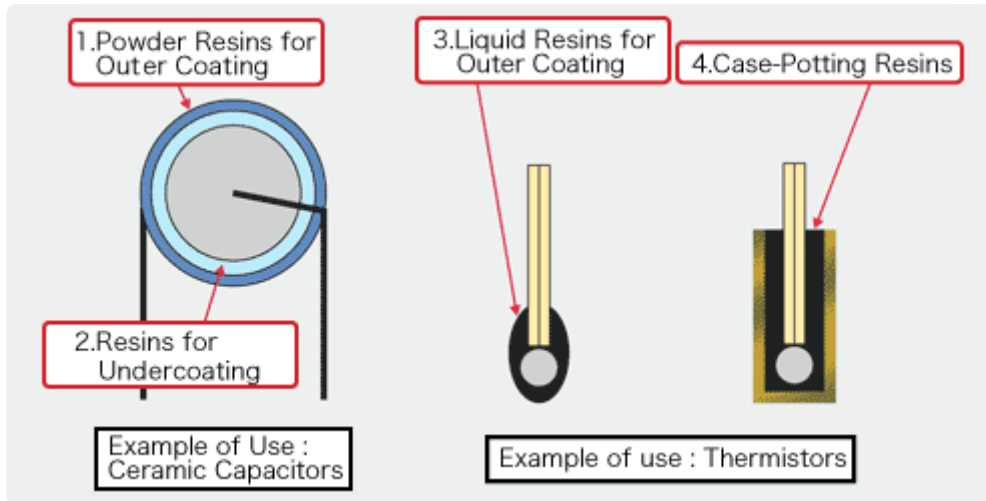
| Applications                     | Features                 | Product Name (Grade) | Curing Condition (°C/min) | Tg Temp Tg (°C) | UL Approval    |
|----------------------------------|--------------------------|----------------------|---------------------------|-----------------|----------------|
| Capacitors, varistors, HIC, etc. | Thermal Shock Resistance | F-250                | 150/90                    | 120             | 94V-0 Approved |
|                                  | Storage Stability        | F-370                | 150/30                    | 95              | 94V-0 Approved |
|                                  | Moisture Resistance      | F-380                | 150/30                    | 95              | 94V-0 Approved |

All numbers are representative values.

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### Features

1. Powder Resins for Outer Coating.
  - Excellent thermal shock/moisture resistance.
  - Laser marking capability.
  - Stable in powder form, thus offers stable quality coated layer.
2. Case-Potting Resins.
  - Low viscosity/fast curable, excellent workability.
  - High thermal conductivity types are also available.



For more information regarding this and other products, please contact us directly.



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